## COMPLETE LISTING OF CLAIMS, INCORPORATING AMENDMENTS IN RESPONSE TO OFFICE ACTION DATED 4/3/2007 FOR SERIAL NO. 10/697,048

- 1.(Original) A photovoltaic conversion device, comprising abutting layers of p-doped diamond and n-doped ultrananocrystalline diamond, whereby irradiation of at least one of said diamond layers produces electron flow between said layers.
- 2.(Original) The photovoltaic device of claim 1, wherein said p-doped diamond is microcrystalline diamond.
- 3. (Original) The photovoltaic device of claim 1, wherein said p-doped diamond is microcrystalline diamond with average grain size in the range of from about 1 micron to about 10 microns.
- 4. (Original) The photovoltaic device of claim 1, wherein said p-doped diamond layer is microcrystalline diamond having a thickness in the range of from about 1 micron to about 5 microns.
- 5. (Original) The photovoltaic device of claim 1, wherein said p-doped diamond is doped with a material having a stable valence state less than four.
- 6.(Original) The photovoltaic device of claim 5, wherein said p-doped diamond is microcrystalline diamond doped with one or more of B, Al, Ga or In.

- 7.(Original) The photovoltaic device of claim 6, wherein said p-doped diamond is microcrystalline diamond doped with B.
- 8.(Original) The photovoltaic device of claim 1, wherein said n-doped ultrananocrystalline diamond is doped with a material having a stable valence state greater than four.
- 9.(Original) The photovoltaic device of claim 1, wherein said n-doped ultrananocrystalline diamond has average grain size in the range of from about 3 nanometers to about 15 nanometers.
- 10.(Original) The photovoltaic device of claim 9, wherein said n-doped ultrananocrystalline diamond has average grain size of less than about 10 nanometers.
- 11. (Original) The photovoltaic device of claim 1, wherein said n-doped ultrananocrystalline diamond is doped with one or more of N, P, Sb or S.
- 12.(Original) The photovoltaic device of claim 1, wherein said n-doped ultrananocrystalline diamond is doped with N.

- 13.(Original) The photovoltaic device of claim 1, wherein said n-doped ultrananocrystalline diamond layer has not less than  $10^{19}$  atom/cm<sup>2</sup> nitrogen with an electrical conductivity at ambient temperature of not less than about 0.1 ( $\Omega$  cm)<sup>-1</sup>.
- 14.(Original) The photovoltaic device of claim 13, wherein said n-doped ultrananocrystalline diamond has grain boundaries that are about 0.2 to about 2.0 nm wide.
- 15.(Original) The photovoltaic device of claim 1, wherein said n-doped ultrananocrystalline diamond layer has a thickness in the range of from about 1 micron to about 5 microns.
- 16.(Original) A photovoltaic device, comprising a layer of p-doped microcrystalline diamond, a layer of n-doped ultrananocrystalline diamond deposited on said layer of p-doped microcrystalline diamond, irradiation of said n-doped ultrananocrystalline diamond layer producing electron flow there between, and electrodes connected to each layer.
- 17. (Original) The photovoltaic device of claim 16, wherein said p-doped diamond is microcrystalline diamond with average grain size in the range of from about 1 micron to about 10 microns.

- 18.(Original) The photovoltaic device of claim 17, wherein said p-doped diamond layer is microcrystalline diamond having a thickness in the range of from about 1 micron to about 5 microns.
- 19.(Original) The photovoltaic device of claim 18, wherein said p-doped diamond is microcrystalline diamond doped with one or more of B, Al, Ga or In.
- 20.(Original) The photovoltaic device of claim 19, wherein said p-doped diamond is microcrystalline diamond doped with B.
- 21.(Original) The photovoltaic device of claim 19, wherein said n-doped ultrananocrystalline diamond is doped with one or more of N, As, Sb or S.
- 22.(Original) The photovoltaic device of claim 21, wherein said n-doped ultrananocrystalline diamond has average grain size up to about 15 nanometers.
- 23.(Original) The photovoltaic device of claim 22, wherein said n-doped ultrananocrystalline diamond has average grain size of less than about 10 nanometers.

- 24.(Original) The photovoltaic device of claim 23, wherein said n-doped ultrananocrystalline diamond layer has a thickness in the range of from about 1 micron to about 5 microns.
- 25.(Original) The photovoltaic device of claim 24, wherein said n-doped ultrananocrystalline diamond layer has not less than  $10^{19}$  atom/cm<sup>2</sup> nitrogen with an electrical conductivity at ambient temperature of not less than about 0.1 ( $\Omega$  cm)<sup>-1</sup>.
- 26.(Original) The photovoltaic device of claim 25, wherein said n-doped ultrananocrystalline diamond has grain boundaries that are about 0.2 to about 2.0 nm wide.
- 27. (Withdrawn) A method of producing a photovoltaic device, comprising providing a substrate in a chamber, providing a first atmosphere containing about 1% by volume  $CH_4$  and about 99% by volume  $H_2$  with dopant quantities of a boron compound, subjecting the atmosphere to microwave energy to deposit a p-doped microcrystalline diamond layer on the substrate, providing a second atmosphere of about 1% by volume  $CH_4$  and about 89% by volume Ar and about 10% by volume  $N_2$ , subjecting the second atmosphere to microwave energy to deposit a n-doped ultrananocrystalline diamond layer on the p-doped microcrystalline diamond layer, and providing leads to conduct electrical energy when the layers are irradiated.

- 28.(Withdrawn) The method of claim 27, wherein the substrate is transparent to solar light.
- 29.(Withdrawn) The method of claim 28, wherein the n-doped nanocrystalline layer is not less than about  $10^{19}$  atom/cm<sup>2</sup> nitrogen with an electrical conductivity at ambient temperature greater than about 0.1 ( $\Omega$  cm)<sup>-1</sup>.
- 30.(Withdrawn) The method of claim 29, wherein said n-doped ultrananocrystalline diamond has grain boundaries that are about 0.2 to about 2.0 nm wide.
- 31.(Withdrawn) The method of claim 30, wherein the n-doped ultrananocrystalline diamond layer is grown on the transparent substrate maintained at a temperature not less than about 350°C during the deposition process.
- 32.(Withdrawn) The method of claim 31, wherein the source of carbon is one or more of  $CH_4$  or a precursor thereof and  $C_2H_2$  or a precursor thereof and a  $C_{60}$  compound.
- 33.(Withdrawn) The method of claim 32, wherein the atomic percent of carbon in the second atmosphere is about 1% and the nitrogen is present in an amount less than about 10% by volume and the balance being a noble gas.

34.(Withdrawn) The method of claim 33, wherein the n-doped ultrananocrystalline diamond is grown on the transparent substrate maintained at a temperature in the range of from about 350 to about 800° at total pressures of not less than about 100 torr.